



9. Statement and signature.  
*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

H. J. Staas, Reg. No. 22,010  
Name of Person Signing

  
Signature

January 28, 2003  
Date

Total number of pages including cover sheet: 3

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# U.S. ASSIGNMENT

S&H 1/00

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by  
(Insert Name(s) & Address(es) of ASSIGNEE(S))

- (1) FUJITSU LIMITED  
1-1, Kamikodanaka 4-chome, Nakahara-ku,  
Kawasaki-shi, Kanagawa 211-8588 Japan
- (2) FUJITSU MEDIA DEVICES LIMITED  
460 Oaza Koyama, Suzaka-shi, Nagano 382-8501 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled  
(Title of Invention)

METHOD OF MAKING DEVICE CHIPS COLLECTIVELY FROM COMMON MATERIAL SUBSTRATE

relating to International Patent Application PCT/JP \_\_\_\_\_ / \_\_\_\_\_ and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on \_\_\_\_\_; (Insert date of execution of application, if not concurrent)

(b) filed on \_\_\_\_\_;

Serial No. \_\_\_\_\_ / \_\_\_\_\_;

Any registered attorney of STAAS & HALSEY LLP, 700 Eleventh Street, N.W., Washington, D.C. 20001 (202/434-1500) is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Typed Name & Signature of Inventor(s))

(Date)

(Typed Name & Signature of Witness(es))

- |    |   |                      |   |
|----|---|----------------------|---|
| 1) | <u>Norinao Kouma</u><br>Norinao Kouma           | <u>Dec 16, 2002</u>  | <u>Ikuyo Kanagawa</u><br>Ikuyo Kanagawa |
| 2) | <u>Yoshihiro Mizuno</u><br>Yoshihiro Mizuno     | <u>Dec 23, 2002</u>  | <u>Ikuyo Kanagawa</u><br>Ikuyo Kanagawa |
| 3) | <u>Hisao Okuda</u><br>Hisao Okuda               | <u>Dec 16, 2002</u>  | <u>Ikuyo Kanagawa</u><br>Ikuyo Kanagawa |
| 4) | <u>Ippei Sawaki</u><br>Ippei Sawaki             | <u>Dec 16, 2002</u>  | <u>Ikuyo Kanagawa</u><br>Ikuyo Kanagawa |
| 5) | <u>Osamu Tsuboi</u><br>Osamu Tsuboi             | <u>Dec 16, 2002</u>  | <u>Ikuyo Kanagawa</u><br>Ikuyo Kanagawa |
| 6) | <u>Yoshitaka Nakamura</u><br>Yoshitaka Nakamura | <u>Dec. 25, 2002</u> | <u>Ikuyo Kanagawa</u><br>Ikuyo Kanagawa |